Preferred Device

Sensitive Gate Triacs

Silicon Bidirectional Thyristors

Designed for industrial and consumer applications for full wave control of AC loads such as appliance controls, heater controls, motor controls, and other power switching applications.

Features

- Sensitive Gate Allows Triggering by Microcontrollers and other Logic Circuits
- Blocking Voltage to 800 Volts
- On-State Current Rating of 12 Amperes RMS at 70°C
- High Surge Current Capability 90 Amperes
- Rugged, Economical TO-220AB Package
- Glass Passivated Junctions for Reliability and Uniformity
- Maximum Values of I_{GT}, V_{GT} and I_H Specified for Ease of Design
- High Commutating di/dt 8.0 A/ms Minimum at 110°C
- Immunity to dV/dt 15 V/μsec Minimum at 110°C
- Operational in Three Quadrants: Q1, Q2, and Q3
- Pb-Free Packages are Available*

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
$\begin{tabular}{lll} Peak Repetitive Off-State Voltage (Note 1) \\ (T_J = -40 to 110 ^{\circ}C, Sine Wave, \\ 50 to 60 Hz, Gate Open) & MAC12SM \\ & MAC12SN \\ \end{tabular}$	V _{DRM,} V _{RRM}	600 800	V
On-State RMS Current (All Conduction Angles; T _C = 70°C)	I _{T(RMS)}	12	А
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T _J = 110°C)	I _{TSM}	90	A
Circuit Fusing Consideration (t = 8.33 ms)	l ² t	33	A ² sec
Peak Gate Power (Pulse Width = 1.0 μ sec, T _C = 70°C)	P _{GM}	16	W
Average Gate Power (t = 8.3 msec, T _C = 70°C)	P _{G(AV)}	0.35	W
Operating Junction Temperature Range	T_J	-40 to 110	°C
Storage Temperature Range	T _{stg}	-40 to 150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

 (V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



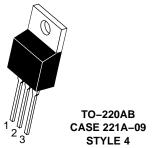
ON Semiconductor®

http://onsemi.com

TRIACS 12 AMPERES RMS 600 thru 800 VOLTS



MARKING DIAGRAM





= M, or N

A = Assembly Location

Y = Year

VW = Work Week

G = Pb-Free Package

PIN ASSIGNMENT			
1	Main Terminal 1		
2	Main Terminal 2		
3	Gate		
4	Main Terminal 2		

ORDERING INFORMATION

Device	Package	Shipping
MAC12SM	TO-220AB	50 Units / Rail
MAC12SMG	TO-220AB (Pb-Free)	50 Units / Rail
MAC12SN	TO-220AB	50 Units / Rail
MAC12SNG	TO-220AB (Pb-Free)	50 Units / Rail

Preferred devices are recommended choices for future use and best overall value.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

THERMAL CHARACTERISTICS

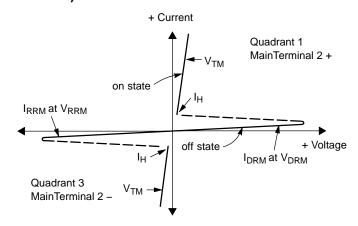
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	2.2 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Peak Repetitive Blocking Current $(V_D = Rated V_{DRM}, V_{RRM}; Gate Open)$	T _J = 25°C T _J = 110°C	I _{DRM} , I _{RRM}	_ _	_ _	0.01 2.0	mA
ON CHARACTERISTICS						
Peak On-State Voltage (Note 2) (I _{TM} = ±17 A)		V _{TM}	-	-	1.85	V
Gate Trigger Current (Continuous dc) (V_D = 12 V, R_L = 100 Ω) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)		I _{GT}	- - -	1.5 2.5 2.7	5.0 5.0 5.0	mA
Holding Current (V _D = 12 V, Gate Open, Initiating Current = ±200 mA)		I _H	-	2.5	10	mA
Latching Current ($V_D = 12 \text{ V}, I_G = 5 \text{ mA}$) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)		ΙL	- - -	3.0 5.0 3.0	15 20 15	mA
Gate Trigger Voltage (Continuous dc) (V_D = 12 V, R_L = 100 Ω) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)		V _{GT}	0.45 0.45 0.45	0.68 0.62 0.67	1.5 1.5 1.5	V
DYNAMIC CHARACTERISTICS						
Critical Rate of Change of Commutating Current ($V_D = 400 \text{ V}$, $I_{TM} = 3.5 \text{ A}$, Commutating dV/dt = 10 V/ μ s, Gate Op f = 500 Hz, Snubber: Cs = 0.01 μ f, Rs = 15 Ω)	en, T _J = 110°C,	(di/dt) _c	8.0	10	-	A/ms
Critical Rate of Rise of Off-State Voltage ($V_D = 67\% \ V_{DRM}$, Exponential Waveform, $R_{GK} = 1 \ K\Omega$, $T_J = 110^\circ$	C)	dV/dt	15	40	-	V/μs
Repetitive Critical Rate of Rise of On-State Current IPK = 50 A; PW = 40 µsec; diG/dt = 1 A/µsec; Igt = 100 mA; f = 6	0 Hz	di/dt	-	-	10	A/μs

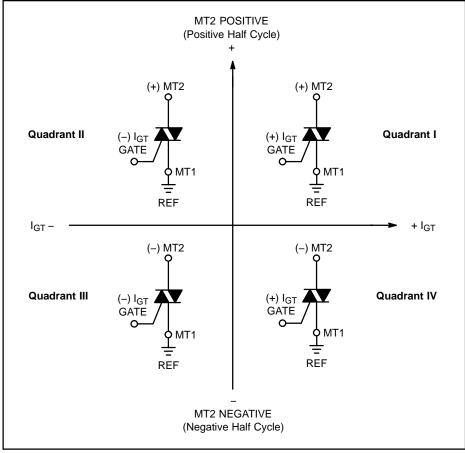
^{2.} Pulse Test: Pulse Width ≤ 2.0 ms, Duty Cycle ≤ 2%.

Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
I _H	Holding Current



Quadrant Definitions for a Triac



All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

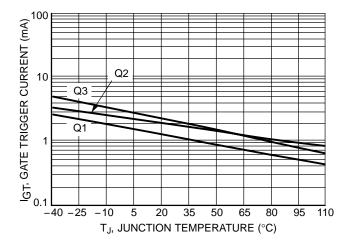


Figure 1. Typical Gate Trigger Current versus Junction Temperature

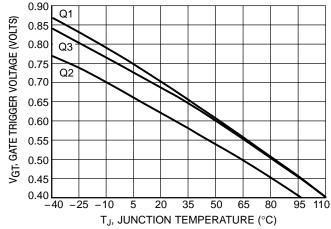
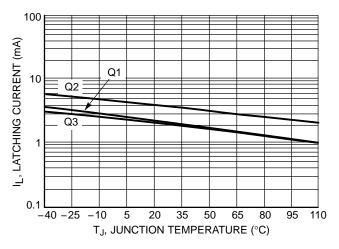


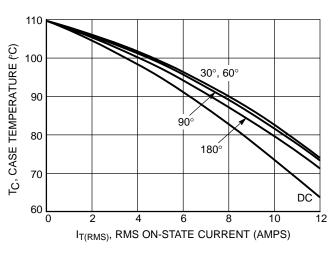
Figure 2. Typical Gate Trigger Voltage versus Junction Temperature



100 (FE) 10 MT2 Positive 1 0.1 -40 -25 -10 5 20 35 50 65 80 95 110 TJ, JUNCTION TEMPERATURE (°C)

Figure 3. Typical Latching Current versus Junction Temperature

Figure 4. Typical Holding Current versus Junction Temperature



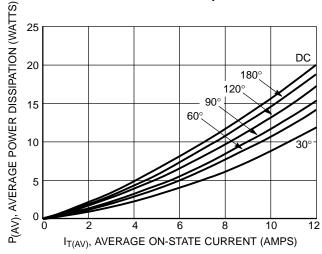
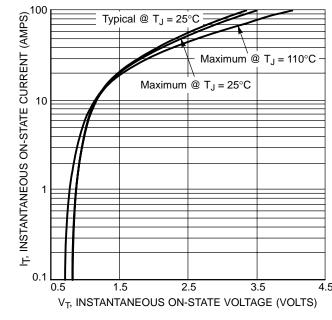


Figure 5. Typical RMS Current Derating

Figure 6. On-State Power Dissipation



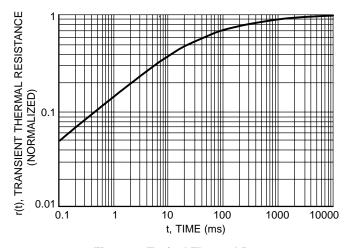
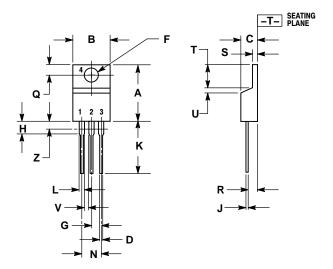


Figure 8. Typical Thermal Response

Figure 7. Typical On-State Characteristics

PACKAGE DIMENSIONS

TO-220AB CASE 221A-09 **ISSUE AA**



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INC	NCHES MILLIMET		IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

STYLF 4

MAIN TERMINAL 1

- 2. MAIN TERMINAL 2
 - GATE
- MAIN TERMINAL 2

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